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Preliminary Specification

PRODUCT NO.: PV0910L9924803000

	CUSTOMER	
	APPROVED BY	
DATE:		
DAIE:		

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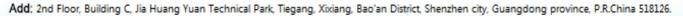


REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
X01	INITIAL RELEASE	2014. 07. 29	
	Modify specification formatAdd the information of module weight		Page 1, 3, 4, 5, 6, 7, 8, 24 & 26

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1. SCOPE

The purpose of this specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured This document, together with the Module Assembly Drawing, is the highest-level specification for this product. It describes the product, identifies supporting documents and contains specifications, which are either not addressed, or are exceptions to the supporting documents.

2. WARRANTY

The products delivered pur suant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). Our company is **b**gated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored in the original packages at 25°C±5°C, 55%±10%RH or used as the conditions specified in the specifications.

Nevertheless, We are not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.

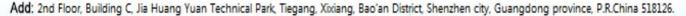
After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

- Small molecular organic light emitting diode.
- Color: White
- Panel matrix : 128*32Driver IC : SSD1307
- Excellent Quick response time: 10µs
- Extremely thin thickness for best mechanism design: 1.21 mm
- High contrast : 2000:1
- Wide viewing angle: 160°
- Serial Peripheral Interface, I²C Interface.
- Strong environmental resistance.
- Wide range of operating temperature : -40 to 70 ℃.
- Anti-glare polarizer.

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4. MECHANICAL DATA

NO	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	128 (W) x 32 (H)	dot
2	Dot Size	0.155 (W) x 0.155 (H)	mm ²
3	Dot Pitch	0.175 (W) x 0.175 (H)	mm ²
4	Aperture Rate	78	%
5	Active Area	22.38 (W) x 5.58 (H)	mm ²
6	Panel Size	30 (W) x 11.5 (H)	mm ²
7*	Panel Thickness	1.02 ± 0.1	mm
8	Module Size	40 (W) x 11.5 (H) x 1.21 (D)	mm ³
9	Diagonal A/A size	0.91	inch
10	Module Weight	0.87 ± 10%	gram

^{*} Panel thickness includes substrate glass, cover glass and UV glue thickness.

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5. MAXIMUM RATINGS

ITEM	MIN	MAX	UNIT	Condition	Remark
Supply Voltage (V _{DD})	-0.3	+4	V	Ta = 25 ℃	IC maximum rating
Supply Voltage (Vcc)	7	16	V	Ta = 25 ℃	IC maximum rating
Operating Temp.	-40	70	∞		-
Storage Temp	-40	85	∞		Note (2)

Note:

- (1) Maximum ratings are those values beyond which damages to the OLED module may occur. The OLED functional operation should be restricted to the limits in the section 6. Electrical Characteristics tables.
- (2) The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80 ℃.

6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETERS	TEST CONDITION	MIN	TYP	MAX	UNIT
	Analog power supply (for OLED panel)	Ta 25℃	11.5	12	12.5	V
V_{DD}	Digital power supply	Ta 25℃	1.65	-	3.3	V
V _{IH}	High logic input level		$0.8* V_{DD}$	-	-	V
V_{IL}	Low logic input level		-	-	$0.2^* V_{DD}$	V
V _{OH}	High logic output level	Iouт = 100uA, 3.3MHz	0.9* V _{DD}	-	-	V
V _{OL}	Low logic output level	Ιουτ = 100uA, 3.3MHz	-	-	0.1* V _{DD}	V

Note: The Vcc input must keep in a stable value; ripple and noise are not allowed.

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6.2 ELECTRO-OPTICAL CHARACTERISTICS

PANEL ELECTRICAL SPECIFICATIONS

PARAMETER	MIN	TYP.	MAX	UNITS	COMMENTS					
Normal mode current		11.5	12.5	mA	All pixels on (1)					
(ICC)		2.5	2.7	mA	20% pixels on (1)					
Standby mode current (ICC)		0.8	1.2	mA	Standby mode 10% pixels on (2)					
Normal mode power		138	150	mW	All pixels on (1)					
consumption		30	32.4	mW	20% pixels on (1)					
Standby mode power consumption		9.6	14.4	mW	Standby mode 10% pixels on (2)					
IDD sleep mode current	-	-	10	uA	Sleep mode Current (3)					
ICC sleep mode current	-	-	10	uA	Sleep mode Current (3)					
Normal mode Luminance	250	300		cd/m ²	Display Average					
Standby mode Luminance		20		cd/m ²						
CIEx (White)	0.26	0.30	0.34		v v (CIE 1021)					
CIEy (White)	0.29	0.33	0.37		x, y (CIE 1931)					
Dark Room Contrast	2000:1									
Viewing Angle	160			degree						
Response Time		10		μs						

(1) Normal mode condition:

Driving Voltage: 12VContrast setting: 0X75Frame rate: 105Hz

- Duty setting: 1/32

(2) Standby mode condition:

Driving Voltage: 12V
Contrast setting: 0X03
Frame rate: 105Hz
Duty setting: 1/32

(3) Sleep mode condition:

When send 0xae command OLED display off and memory data will be maintained.

(4) Wake up condition:

When send 0xaf command OLED will be turned on.

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7. LIFETIME SPECIFICATION

ITEM	MIN	UNIT	Condition	Remark
Life Time	9,400	Hrs	350 cd/m ² , 50%	Note (1)
Life Tillie	9,400	1115	checkerboard	Note (1)
Life Time	11,000	Hrs	300 cd/m ² , 50%	Note (2)
LITE THITE	11,000	1115	checkerboard	11016 (2)
Life Time	13,000	Hrs	250 cd/m ² , 50%	Note (3)
Life Tillie	13,000	1115	checkerboard	Note (3)

Note:

(A) Under VCC = 12V, Ta = 25° C, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(1) Setting of 350 cd/m²:

- Contrast setting: 0x8d

- Frame rate: 105Hz

- Duty setting: 1/32

(2) Setting of 300 cd/m²:

- Contrast setting: 0x75

- Frame rate: 105Hz

- Duty setting: 1/32

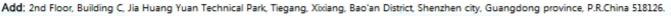
(3) Setting of 250 cd/m²:

Contrast setting: 0x5f

Frame rate: 105Hz

- Duty setting: 1/32

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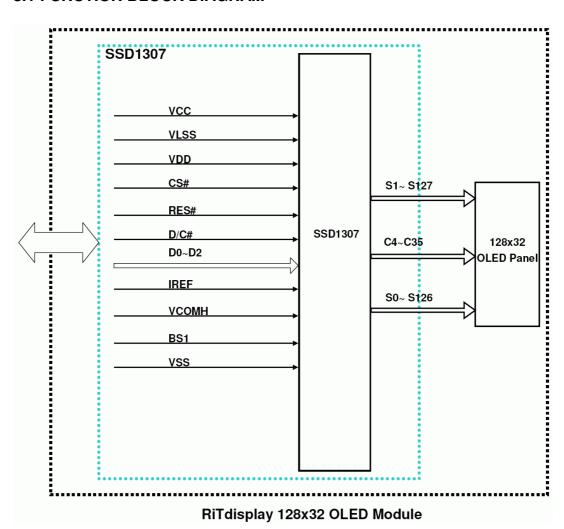
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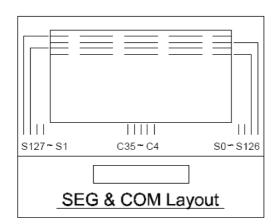


8. INTERFACE

8.1 FUNCTION BLOCK DIAGRAM



8.2 PANEL LAYOUT DIAGRAM



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8.3 PIN ASSIGNMENTS

Pin No.	Pin Name	Description
1	VCC	Power supply for panel driving voltage.
2	VLSS	Ground pin. It should be connected to VSS externally.
3	VDD	Power supply for logic circuit.
4	CS#	Chip select input.
5	RES#	Reset signal input.
6	D/C#	This is Data/Command control pin. In I ² C mode, this pin acts as SA0 for slave address selection.
7	D0	When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SDIN and
8	D1	D2 should be kept NC. When I ² C mode is selected, D2, D1 should be tied together
9	D2	and serve as SDA _{out} , SDA _{in} in application and D0 is the serial clock input, SCL.
10	IREF	Reference current input pin. A resistor should be connected between this pin and VSS.
11	VCOMH	Com Voltage Output. A capacitor should be connected between this pin and VSS.
12	VCC	Power supply for panel driving voltage.
13	BS1	MCU bus interface selection pin.
14	VSS	Ground pin.

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8.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 128 x 39 bits and the RAM is divided into five pages, from PAGE0 to PAGE4, which are used for monochrome 128x39 dot matrix display, as shown in below figures.

When one data byte is written into GDDRAM, all the rows image data of the same page of the current column are filled (i.e. the whole column (8 bits) pointed by the column address pointer is filled.). Data bit D0 is written into the top row, while data bit D7 is written into bottom row. For PAGE4, bit D7 is treated as don't care bit.

For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. For vertical shifting of the display, an internal register storing the display start line can be set to control the portion of the RAM data to be mapped to the display (command D3h).

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GDDRAM pages structure of SSD1307

mapping	ment re- y (command A1h)	SEG127	SEG126	SEG125	SEG124		SEG4	SEGS	SEG2	SEG1	SEGO		
mapping	egment re- ing (command 0 5 8 8 h [RESET])			SEG123	SEG124	SEG125	SEG126	SEG127					
Page	Data	COLO	∞L1	0012	യദ		∞L123	00L124	∞L125	∞L126	∞L127	COM Output Scan Direction (command C0h [RESET])	COM Output Scan Direction (command C8h)
	D0	Ť	ĺ							Ť		COM0	COM38
	D1		10	5 5			3 8	6				COM1	COM37
	D2		9	9 8			4	Ŷ ſ			1	COM2	COM36
0	D3		1	22 23			2 1	Î Î				COM3	COM35
	D4		0					0 (COM4	COM34
	D5	,		2 3			y 90	· 5			c 6:	COM5	COM33
	D6		. 0	9 3				ø-,				COM6	COM32
	D7		8 9	0 0								COM7	COM31
1	D0											COM8	COM30
	D1		. (0 (COM9	COM29
	D2											COM10	COM28
1	D3		. 0	§ 9			1	8 v			. 4	COM11	COM27
	D4		9	9 8			1	9				COM12	COM26
	D5											COM13	COM25
	D6									ш		COM14	COM24
-	D7			2 2								COM15	COM23
*	D0		- 8	1	-							COM16	COM22
	D1				-	Each box repre	sen	ts o	ne	bit		COM17	COM21
	D2			2 3		of image data				-		COM18	COM20
2	D3			0 0	\vdash	********) 6	7.			s 46	COM19	COM19
6888	D4 D5		9 89	5 5		25-592-592	2 22	8 1		ш	5 Kr	COM20	COM18 COM17
	D6									ш		COM21 COM22	COM17 COM16
	D6				\vdash					\vdash		COM22 COM23	COM15
	D0		\vdash	\vdash	\vdash					\vdash		COM24	COM14
	D0			2 /	\vdash			4		\vdash		COM25	COM14 COM13
	D2			8 8	\vdash		2 22	8 1	\vdash	\vdash	1 1/2	COM26	COM13
	D2		- 30	2 9	\vdash			9 3	\vdash	\vdash		COM27	COM12 COM11
3	D3			2 0	\vdash				\vdash	\vdash		COM28	COM10
	D5				\vdash		-		\vdash	\vdash		COM29	COM10 COM9
	D6			2 1	\vdash				\vdash	\vdash	- 4	COM30	COM8
	D7		1 1	9 9			5 89	8 9		Н	1	COM31	COM7
	D0		(3)				- 8			\vdash		COM32	COM6
	D1											COM32	COM5
	D2			-	\vdash					\vdash		COM34	COM4
4	D3		- 72	3 8	\vdash					Н		COM35	COM3
7	D4		- 0	9 9				9				COM36	COM2
	D5		- 8	× 2	\vdash		3 8	-		\vdash	C (6)	COM37	COM1
	D6			-	\vdash			2	\vdash	\vdash		COM38	COMO
	D7				_	Don't care bit	_		_	_			

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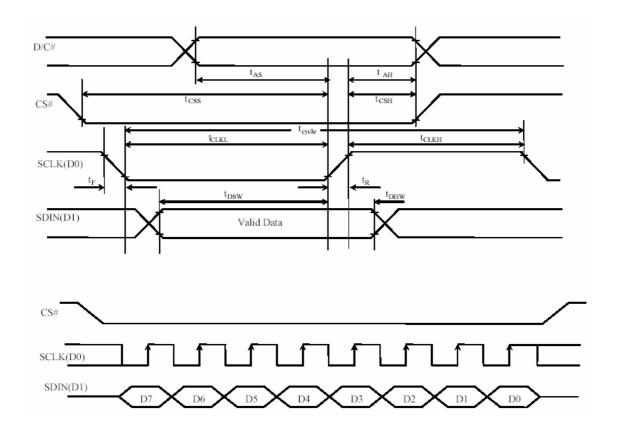


8.5 INTERFACE TIMING CHART

Serial Interface Timing Characteristics (4-wire SPI)

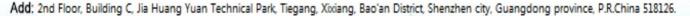
$$(V_{DD} - V_{SS} = 1.65 V \sim 3.3 V, T_A = 25 °C)$$

Symbol	Parameter	Min	Тур	Max	Unit
t _{cvcle}	Clock Cycle Time	100	-	-	ns
tas	Address Setup Time	15	-	-	ns
t _{AH}	Address Hold Time	15	-	-	ns
t _{CSS}	Chip Select Setup Time	20	-	-	ns
t _{CSH}	Chip Select Hold Time	10	-	-	ns
t _{DSW}	Write Data Setup Time	15	-	-	ns
t _{DHW}	Write Data Hold Time	15	-	-	ns
t _{CLKL}	Clock Low Time	20	-	-	ns
t _{CLKH}	Clock High Time	20	-	-	ns
t_R	Rise Time	-	-	40	ns
t _F	Fall Time	-	-	40	ns



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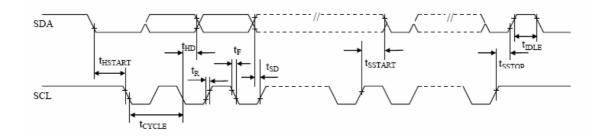
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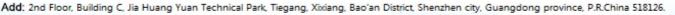


I2C Interface Timing Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	2.5	-	-	us
t _{HSTART}	Start condition Hold Time	0.6	-	-	us
t _{HD}	Data Hold Time (for "SDA _{OUT} " pin)	0	-	-	ns
	Data Hold Time (for "SDA _{IN} " pin)	300	-	-	ns
t _{SD}	Data Setup Time	100	-	-	ns
t _{SSTART}	Start condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	-	us
t _{SSTOP}	Stop condition Setup Time	0.6	-	-	us
t _R	Rise Time for data and clock pin	-	-	300	ns
t _F	Fall Time for data and clock pin	-	-	300	ns
t _{IDLE}	Idle Time before a new transmission can start	1.3	-	-	us



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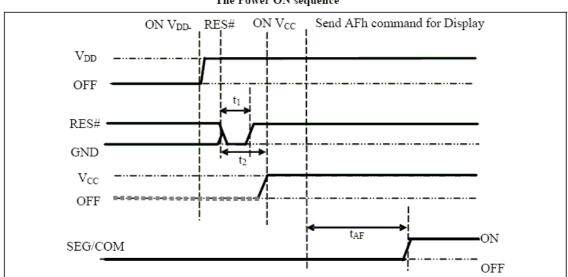
9. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

9.1 POWER ON / OFF SEQUENCE

Power ON sequence:

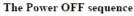
- 1. Power ON VDD
- 2. After V_{DD} become stable, set RES# pin LOW (logic low) for at least 3us (t₁) ⁽³⁾ and then HIGH (logic high).
- 3. After set RES# pin LOW (logic low), wait for at least 3us (t2). Then Power ON Vcc. (1)
- 4. After Vcc become stable, send command AFh for display ON. SEG/COM will be ON after 100ms (taf).

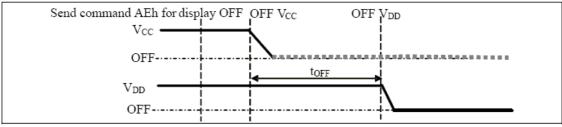
The Power ON sequence



Power OFF sequence:

- 1. Send command AEh for display OFF.
- 2. Power OFF Vcc (1), (2)
- 3. Power OFF V_{DD} after t_{OFF} . (where Minimum t_{OFF} =80ms, Typical t_{OFF} =100ms)





Note:

- (1)V_{CC} should be disabled when it is OFF.
- $^{(2)}$ Power Pins (V_DD, V_CC) can never be pulled to ground under any circumstance.
- (3) The register values are reset after t₁.
- (4) V_{DD} should not be Power OFF before V_{CC} Power OFF.

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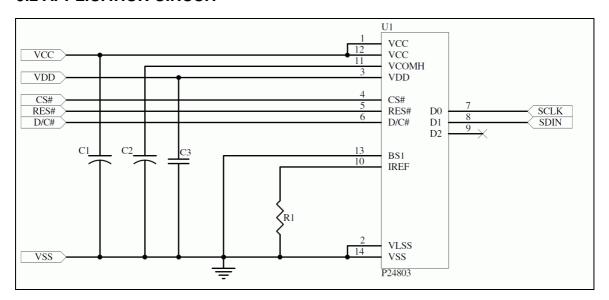
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9.2 APPLICATION CIRCUIT



Recommend components:

C1,C2: 4.7uF/25V(Tantalum type) or VISHAY (572D475X0025A2T)

C3: 1uF/16V(0603)

R1: 2M ohm / 1% (0603)

This circuit is for SPI interface.

9.3 COMMAND TABLE

Refer to SSD1307 IC Spec.

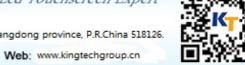
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10. RELIABILITY TEST CONDITIONS

No.	Items	Specification	Quantity
1	High temp. (Non-operation)	85℃, 240hrs	5
2	High temp. (Operation)	70 ℃, 120hrs	5
3	Low temp. (Operation)	-40℃, 120hrs	5
4	High temp. / High humidity (Operation)	65℃, 90%RH, 120hrs	5
5	Thermal shock (Non-operation)	-40 °C ~85 °C (-40 °C /30min; transit /3min; 85 °C /30min; transit /3min) 1cycle: 66min, 100 cycles	5
6	Vibration	Frequency: 5~50HZ, 0.5G Scan rate: 1 oct/min Time: 2 hrs/axis Test axis: X, Y, Z	1 Carton
7	Drop	Height: 120cm Sequence : 1 angle \ 3 edges and 6 faces Cycles: 1	1 Carton
8	ESD (Non-operation)	Air discharge model, ±8kV, 10 times	5

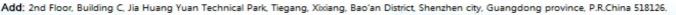
Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for item 1, 4 & 5.

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

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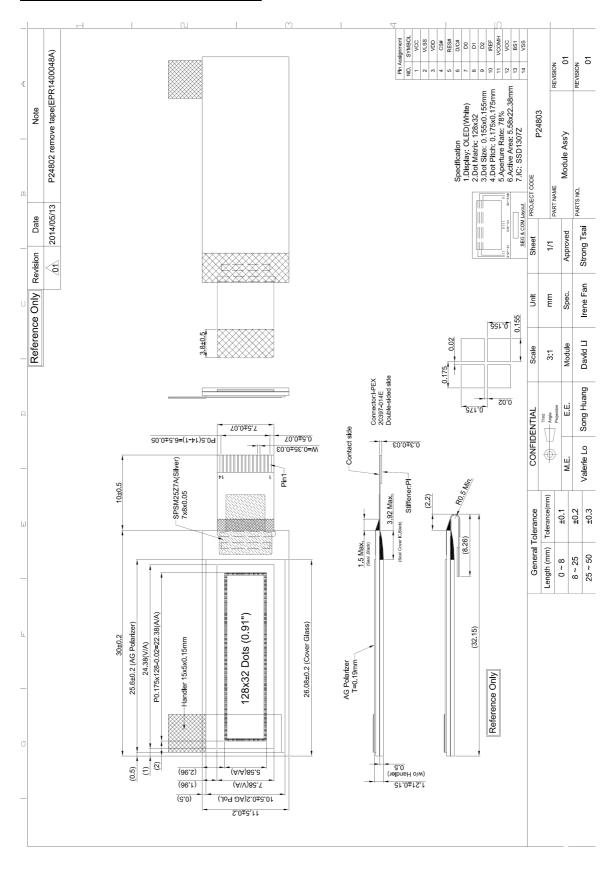
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11. EXTERNAL DIMENSION



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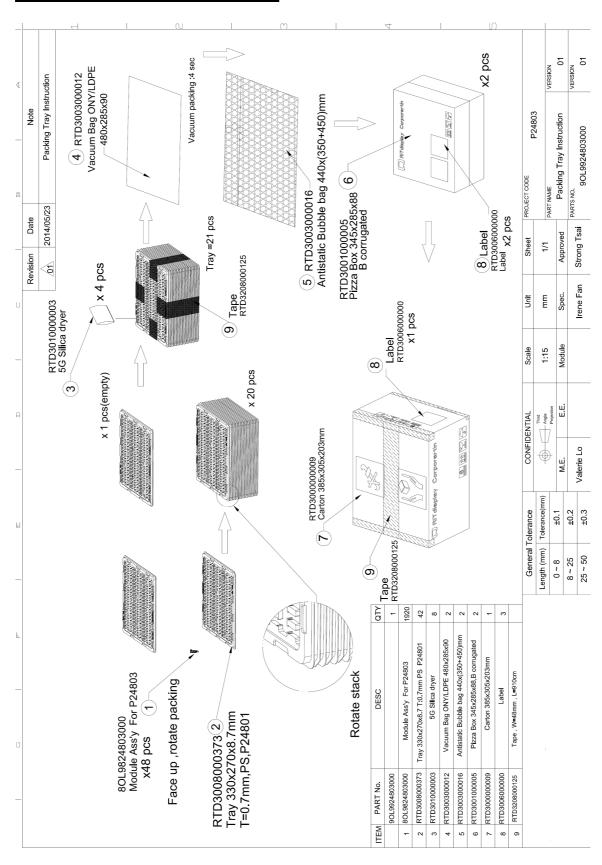
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12. PACKING SPECIFICATION



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13. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.

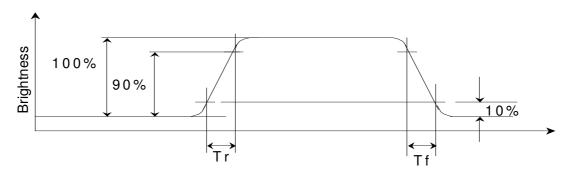
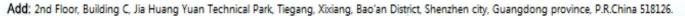


Figure 2 Response time

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D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.

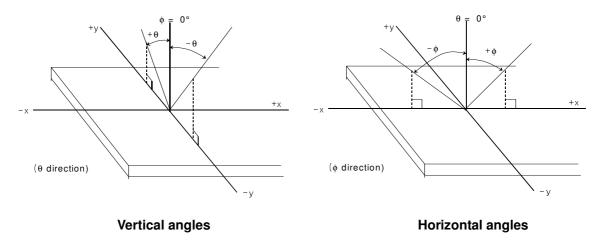


Figure 3 Viewing Angle

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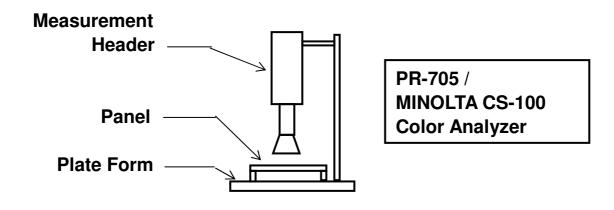
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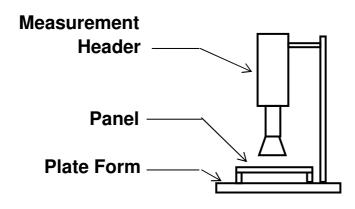
APPENDIX 2: MEASUREMENT APPARATUS A. LUMINANCE/COLOR COORDINATE

PHOTO RESEARCH PR-705, MINOLTA CS-100



B. CONTRAST / RESPONSE TIME / VIEWING ANGLE

WESTAR CORPORATION FPM-510



Westar FPM-510
Display Contrast /
Response time /
View angle Analyzer

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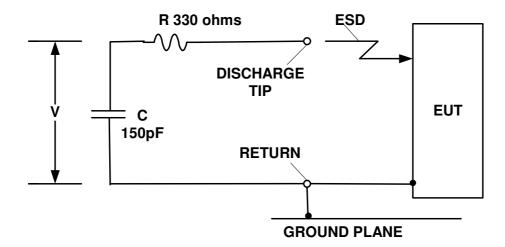
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C. ESD ON AIR DISCHARGE MODE



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APPENDIX 3: PRECAUTIONS FOR USING THE OLED MODULE

Precautions for Handling

- 1. When handling the module, wear powder-free antistatic rubber finger cots, and be careful not to bend and twist it.
- 2. The OLED module is consisted of glass and film, and it should avoid pressure, strong impact, or being dropped from a high position.
 - 3. The OLED module is an electronic component and is subject to damage caused by Electro Static Discharge (ESD). And hence normal ESD precautions must be taken when handling it. Also, appropriate ESD protective environment must be administered and maintained in the production line. When handling and assembling the panel, wear an antistatic wrist strap with the alligator clip attached to the ground to prevent ESD damage on the panel. Antistatic wrist strap should touch human body directly instead of gloves. (See below photos).





- 4. Take out the panel one by one from the holding trays for assembly, and never put the panel on top of another one to avoid the scratch.
- 5. Avoid jerk and excessive bend on TAB/FPC/COF, and be careful not to let foreign matter or bezel damage the film.
- 6. When handling and assembling the module (panel + IC), grab the panel, not the TAB/FPC/COF.
- 7. Use the tweezers to open the clicks on the connector of PCB before the insertion of FPC/COF, and click them back in. Once the FPC/COF sits properly in the connector, use the tweezers to avoid the damages.







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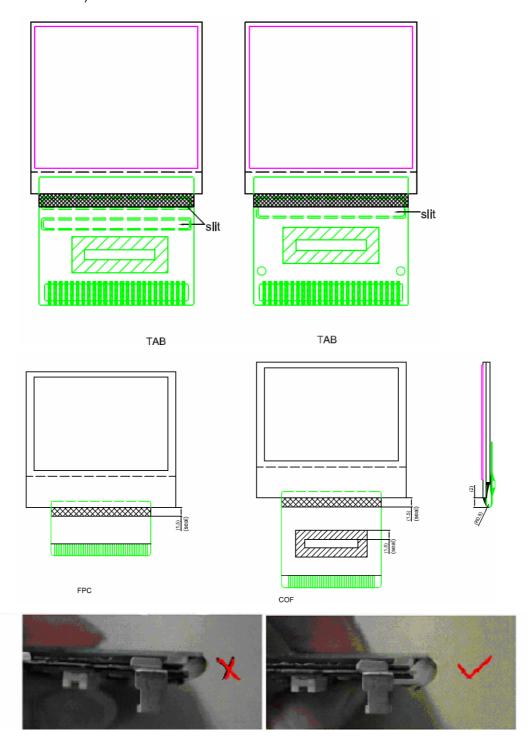
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8. Please do not bend the film near the substrate glass. It could cause film peeling and TAB/FPC/COF damage. For TAB, It should bend the slit area as actual OLED it is. For FPC or COF, it is suggested to follow below pictures for instruction (distance between substrate glass and bending area >1.5mm; R>0.5mm).



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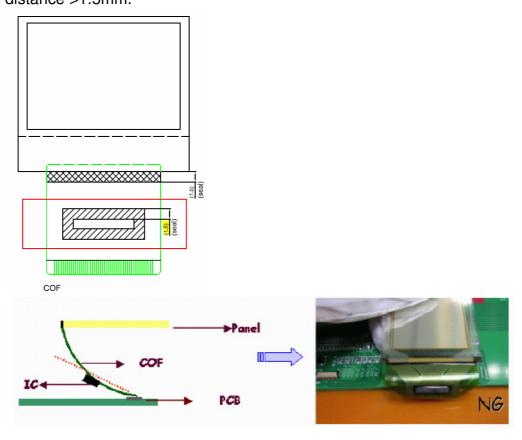
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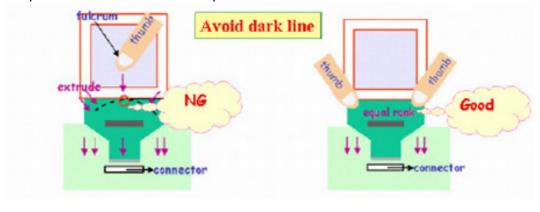
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9. Avoid bending the film at IC bonding area. It could damage the IC ILB bonding. It should avoid bending the IC seal area. Please keep the bending distance >1.5mm.



10. Use both thumbs to insert COF into the connector when assembling the panel. Please refer to the photo.



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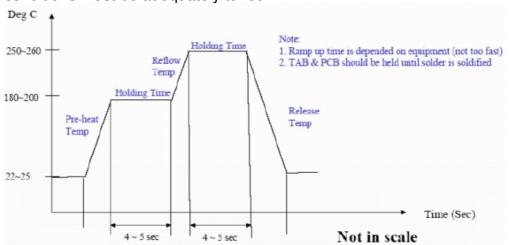
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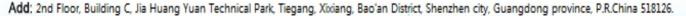


- 11. Do not wipe the pin of film and polarizer with the dry or hard materials that will damage the surface. When cleaning the display surface, use the soft cloth with solvent, IPA or alcohol, to clean.
- 12. Protection film is applied to the surface of OLED panel to avoid the scratch. Please remove the protective film before assembling it. If the OLED panel has been stored for a long time, the residue adhesive material of the protective film may remain on the display surface after remove the protective film. Please use the soft cloth with solvent, IPA or alcohol, to clean.
- 13. When hand or hot-bar soldering TAB/FPC onto PCB, make sure the temperature and timing profiles to meet the requirements of soldering specification (the specification depends on the application or optimized by customer) to prevent the damage of IC pins by inappropriate soldering.
- 14. Solder residues arise from soldering process have to be cleaned up thoroughly before the module assembly.
- 15. Use the voltage and current settings listed in the specification to do the function test after the module assembly.
- 16. Suggestion for soldering process:
 - i. TAB Lead- free soldering hot bar process
 - 1. Use pulse heated bonding tool equipment
 - 2. Material: Sn/Ag/Cu lead-free solder paste with typical 25um thickness on PCB pad. The TAB pin size and shape may be different, please base on the production line to adjust the thickness of PCB pad and temperature.
 - 3. Bonding Force:--4kg per centimeter square as the starting point.
 - 4. Suggested bonding tool temperature & time profile is as below for reference. Since there are differences in TAB soldering pins, soldering technicians' skills, mechanism...etc., the soldering conditions must be adequately tuned.



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- ii. TAB Lead- free soldering wire process In case of manual soldering (Lead- free solder wire)
 - 1. Solder wire contact iron directly: 280±5° at 3-5secs
 - 2. Solder wire contact TAB lead directly (near iron but not contact): 380 ± 5 °C , 3-5secs
 - 3. Since there are differences in TAB soldering pins, soldering technicians' skills, mechanism...etc., the soldering conditions must be adequately tuned.
- iii. High temperature will result in rapid heat conduction to IC and might cause damage to IC, so please keep the temperature below 380 $^{\circ}$ C. Also, avoid damaging the polyimide and solder resist which might take place at high temperatures. Refold cycles base on the de-soldering status, if the plating of pin was damaged, it can not be used again.

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Precautions for Electrical

1. Design using the settings in the specification

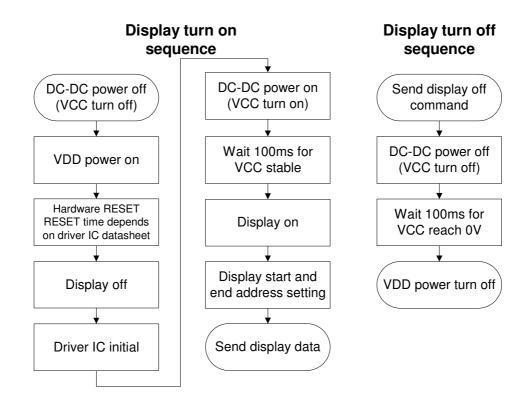
It is very important to design and operate the panel using the settings listed in the specification. It includes voltage, current, frame rate and duty cycle... etc. Operation the OLED outside the range of the specification should be entirely avoided to ensure proper operation of the OLED.

2. Maximum Ratings

To ensure the proper operation of the panel, never design the panel with parameters running over the maximum ratings listed in the specification. Also the logic voltages such as VIL and VIH have to be within the specified range in the specification to prevent any improper operation of the panel.

3. Power on/off procedure

To avoid any inadvertent effects resulting from inappropriate power on/off operations, please follow the directions of power on/off procedure on page 6. Any operation that does not comply with the procedure could cause permanent damage of the IC and should be avoided. When the logic power is not on, do not activate any input signal. Abrupt shutdown of power to the module, while the OLED panel is on, would cause OLED panel malfunction.



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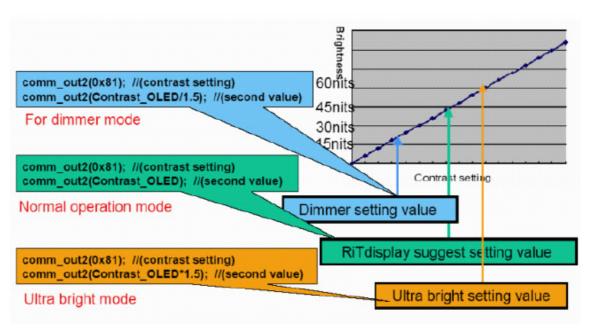
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4. Power savings

To save power consumption of the OLED, please use partial display or sleep mode when the panel is not fully activated. Also, if possible, make the black background to save power.

The OLED is a self-luminous device and a particular pixel cluster or image can be lit on via software control. So power savings can be achieved by partial display or dimming down the luminance. Depending on the application, the user can choose among Ultra Bright Mode, Normal Operation Mode, and Sleeping Mode. The power consumption is almost in directly proportion to the brightness of the panel, and also in directly proportion to the number of pixels lit on the panel. The customer can save the power by the use of black background and sleeping mode. One benefit from using these design schemes is the extension of the OLED lifetime.



5. Adjusting the luminance of the panel

Although there are a couple of ways to adjust the luminance of the panel, it is strongly recommended that the customer change the contrast setting to adjust the luminance of the panel. Adjusting voltages to achieve desired luminance is not allowed. Be aware that the adjustment of luminance would accompany the change of lifetime of the panel and its power consumption as well.

6. Residual Image (Image Sticking)

The OLED is a self-emissive device. As with other self-emissive device or displays consisting of self-emissive pixels, when a static image frozen for a long period of time is changed to another one with all-pixels-on background, residual image or image sticking is noticed by the human eye. Image sticking is due to the luminance difference or contrast between the pixels that were previously turned on and the pixels that are newly turned on. Image sticking depends on the luminance decay curve of the display. The slower the decay, the less prominent the image sticking is. It is strongly recommended that the user employ the following three strategies to minimize image sticking.

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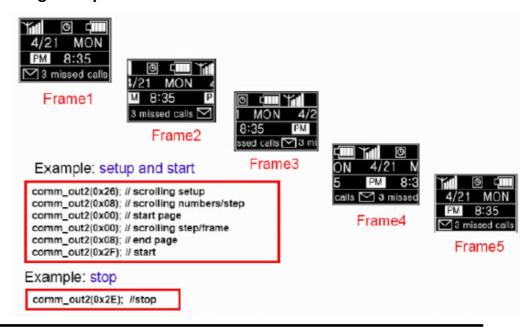


- Employ image scrolling or animation to even out the lit-on time of each and every pixel on the display, also could use sleeping mode for reduced the residual image and extend the power capacity.
- 2. <u>Minimize the use of all-pixels-on or full white background</u> in their application because when the panel is turned on full white, the image sticking from previously shown patterns is the most revealing. Black background is the best for power savings, greatest visibility, eye appealing, and dazzling displays
- 3. If a static logo is used in the reliability test, change the pattern into its inverse (i.e., turn off the while pixels and turn on the previously unlit pixels) and freeze the inverse pattern as long as the original logo is used, so every pixel on the panel can be lit on for about the same time to minimize image sticking, caused by the differential turn-on time between the original and its reverse patterns.

Black Background



Scrolling example



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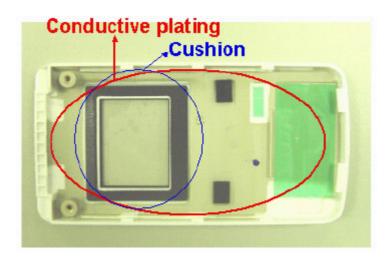
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Precautions for Mechanical

1. Cushion or Buffer tape on the cover glass

It is strongly recommended to have a cushion or buffer tape to apply on the panel backside and front side when assembling OLED panel into module to protect it from damage due to excessive extraneous forces.



It is recommended that a plating conductive layer be used in the housing for EMI/EMC protection. And, the enough space should be reserved for the IC placement if the IC thickness is thicker than the TAB film when customer design the PCB.

2. Avoid excessive bending of film when handling or designing the panel into the product

The bending of TAB/COF/FPC has to follow the precautions indicated in the specification, extra bending or excessive extraneous forces should be avoided to minimize the chances of film damage. If bending the film is necessary, please bend the designated bending area only. Please refer to items 8 and 9 of Precautions for Handling for more information.

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Precautions for Storage and Reliability Test

1. Storage

Store the packed cartons or packages at $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, $55\% \pm 10\%$ RH. Do not store the OLED module under direct sunlight or UV light. For best panel performance, unpack the cartons and start the production of the panels within six months after the reception of them.

2. Reliability Test

We only guarantees the reliability of the OLEDs under the test conditions and durations listed in the specification.

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